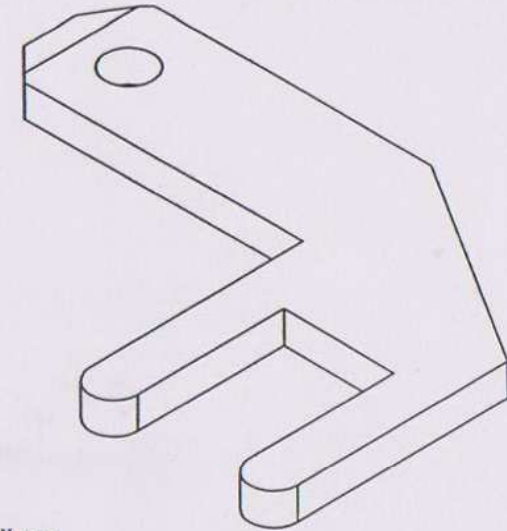


REVISION RECORD				
REV	ECD	DESCRIPTION	DRFT	DATE



Notes:

1. Material: H62 H/2, T=0.8mm;
2. Plating: Cu plated at the bottom is more than 2um; Ni plated on the surface is more than 2um; Sn plated at the bottom is more than 4um;
3. Undimensioned Tolerances:

Pitch range in mm		Nominal dimension range in mm						—
to	over	to	over	over	over	over	—	
6	6	10	10	30	60	100	150	∩
10	10	24	30	60	100	150	∩	□
±0.10	±0.15	±0.25	±0.2	±0.3	±0.5	±0.7	±1.0	0.05/0



1	K16	C1610	H62	SnCe	
ITEM	NAME OF PART	NO. OF PART	Q*TY	MATERIAL	NOTES
MM CINCH	DATE 11/11/08	DATE 10-30-07	宁波高正电子有限公司 DEGSON ELECTRONICS CO., LTD		
TOLERANCES EXCEPT AS NOTED		DATE	NAME		
MM	+	APPRV. <i>Hang</i> DATE 10/12/07	K16-00A(H)		
.005	*	MATERIAL :	DRAWING NO. K16-E01		
.008	*	ANGLES ± 1°	/PART NO.		
THIRD ANGLE PROJECTION		FINISH:	DO NOT SCALE DRAWING		SIZE A4
SCALE: 1:1		SHEET 1		REV TO 10/23/07	
			OF 1		